

BCR08AM-12A

Triac

Low Power Use

REJ03G0343-0200

Rev.2.00

Nov 30, 2007

Features

- $I_{T(RMS)}$: 0.8 A
- V_{DRM} : 600 V
- I_{RGTI} , $I_{RGT III}$: 5 mA
- Planar Passivation Type

Outline

RENESAS Package code: PRSS0003EA-A
(Package name: TO-92)

1. T₁ Terminal
2. T₂ Terminal
3. Gate Terminal

Applications

Electric fan, air cleaner, and other general purpose control applications

Maximum Ratings

Parameter	Symbol	Voltage class	Unit
		12	
Repetitive peak off-state voltage ^{Note1}	V_{DRM}	600	V
Non-repetitive peak off-state voltage ^{Note1}	V_{DSM}	720	V

Parameter	Symbol	Ratings	Unit	Conditions
RMS on-state current	$I_{T(RMS)}$	0.8	A	Commercial frequency, sine full wave 360° conduction, $T_c = 56^\circ\text{C}$
Surge on-state current	I_{TSM}	8	A	60Hz sine wave 1 full cycle, peak value, non-repetitive
I^2t for fusing	I^2t	0.26	A^2s	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current
Peak gate power dissipation	P_{GM}	1	W	
Average gate power dissipation	$P_{G(AV)}$	0.1	W	
Peak gate voltage	V_{GM}	6	V	
Peak gate current	I_{GM}	0.5	A	
Junction temperature	T_j	- 40 to +125	$^\circ\text{C}$	
Storage temperature	T_{stg}	- 40 to +125	$^\circ\text{C}$	
Mass	—	0.23	g	Typical value

Notes: 1. Gate open.

Electrical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test conditions
Repetitive peak off-state current	I_{DRM}	—	—	1.0	mA	$T_j = 125^\circ\text{C}$, V_{DRM} applied
On-state voltage	V_{TM}	—	—	2.0	V	$T_c = 25^\circ\text{C}$, $I_{TM} = 1.2\text{ A}$, Instantaneous measurement
Gate trigger voltage ^{Note2}	II V_{RGTI}	—	—	2.0	V	$T_j = 25^\circ\text{C}$, $V_D = 6\text{ V}$, $R_L = 6\ \Omega$, $R_G = 330\ \Omega$
	III V_{RGTIII}	—	—	2.0	V	
Gate trigger current ^{Note2}	II I_{RGTI}	—	—	5	mA	$T_j = 25^\circ\text{C}$, $V_D = 6\text{ V}$, $R_L = 6\ \Omega$, $R_G = 330\ \Omega$
	III I_{RGTIII}	—	—	5	mA	
Gate non-trigger voltage	V_{GD}	0.1	—	—	V	$T_j = 125^\circ\text{C}$, $V_D = 1/2 V_{DRM}$
Thermal resistance	$R_{th(j-c)}$	—	—	60	$^\circ\text{C/W}$	Junction to case ^{Note3}
Critical-rate of rise of off-state commutating voltage ^{Note4}	$(dv/dt)_c$	0.5	—	—	$\text{V}/\mu\text{s}$	$T_j = 125^\circ\text{C}$

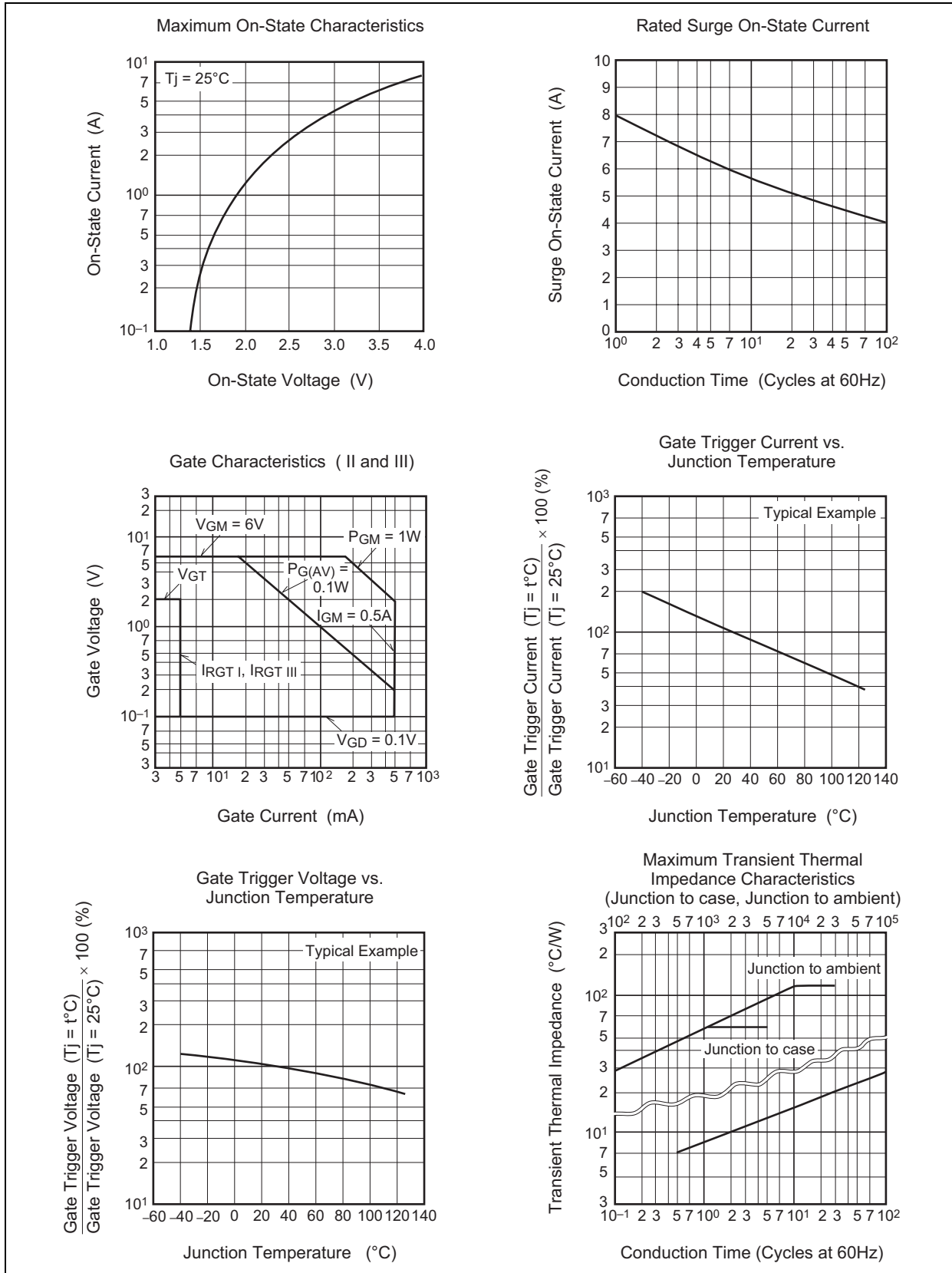
Notes: 2. Measurement using the gate trigger characteristics measurement circuit.

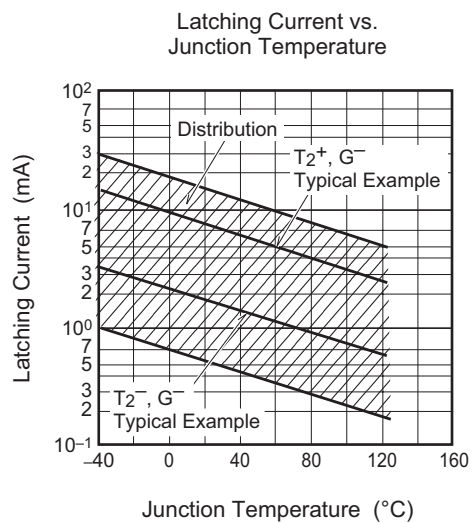
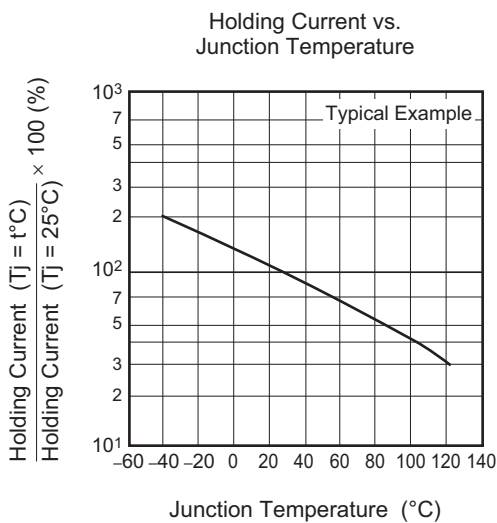
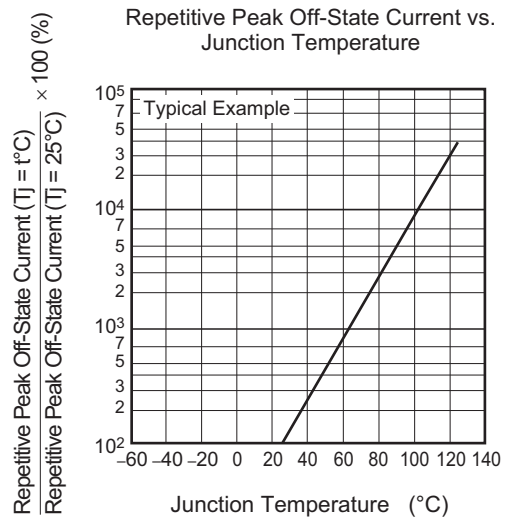
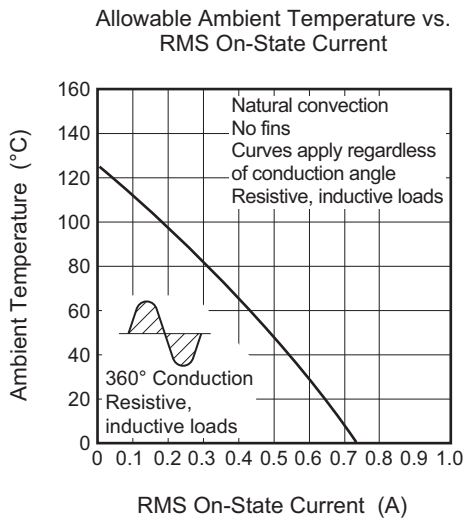
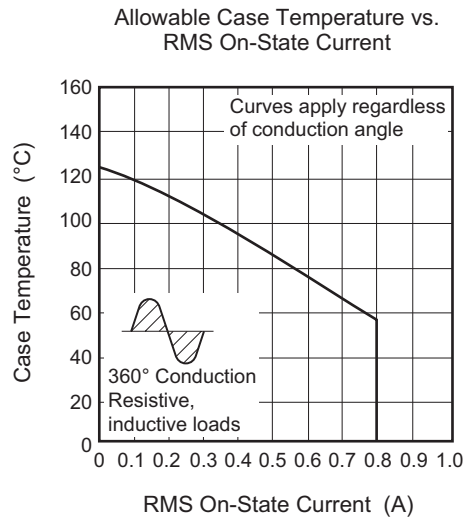
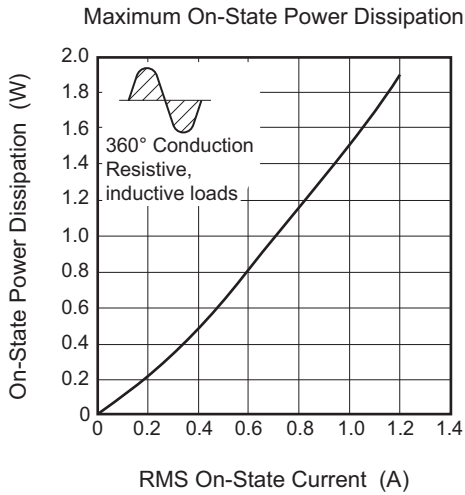
3. Case temperature is measured at the T_2 terminal 1.5 mm away from the molded case.

4. Test conditions of the critical-rate of rise of off-state commutating voltage is shown in the table below.

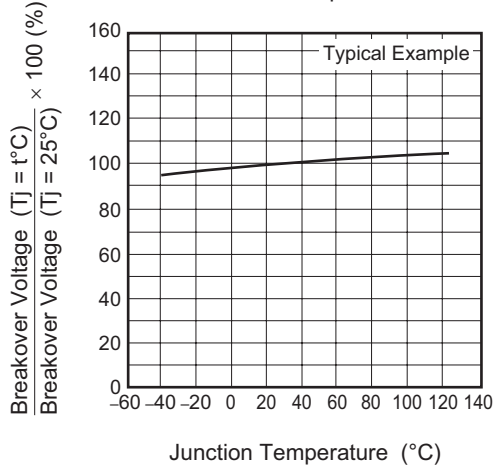
Test conditions	Commutating voltage and current waveforms (inductive load)
1. Junction temperature $T_j = 125^\circ\text{C}$ 2. Rate of decay of on-state commutating current $(di/dt)_c = -0.4\text{ A/ms}$ 3. Peak off-state voltage $V_D = 400\text{ V}$	

Performance Curves

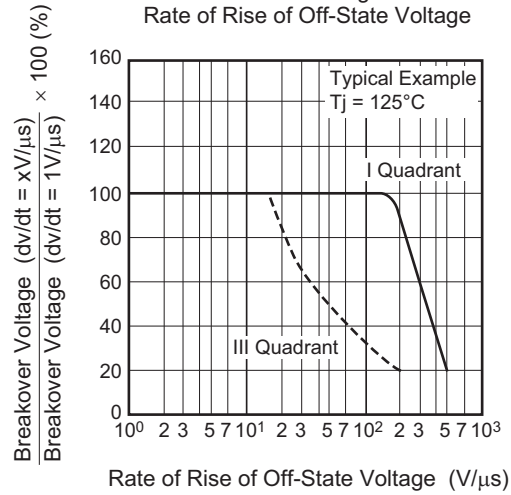




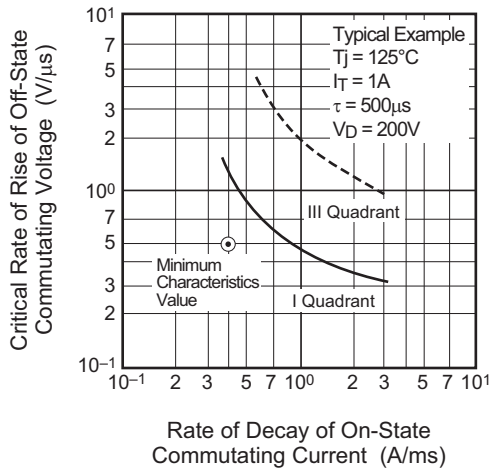
Breakover Voltage vs. Junction Temperature



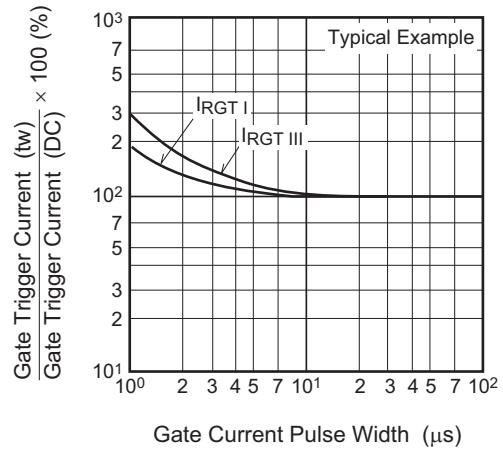
Breakover Voltage vs. Rate of Rise of Off-State Voltage



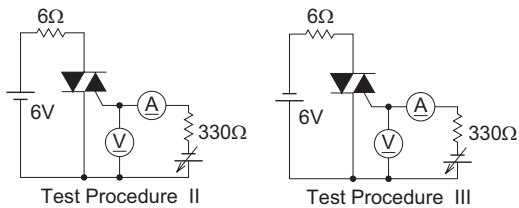
Commutation Characteristics



Gate Trigger Current vs. Gate Current Pulse Width

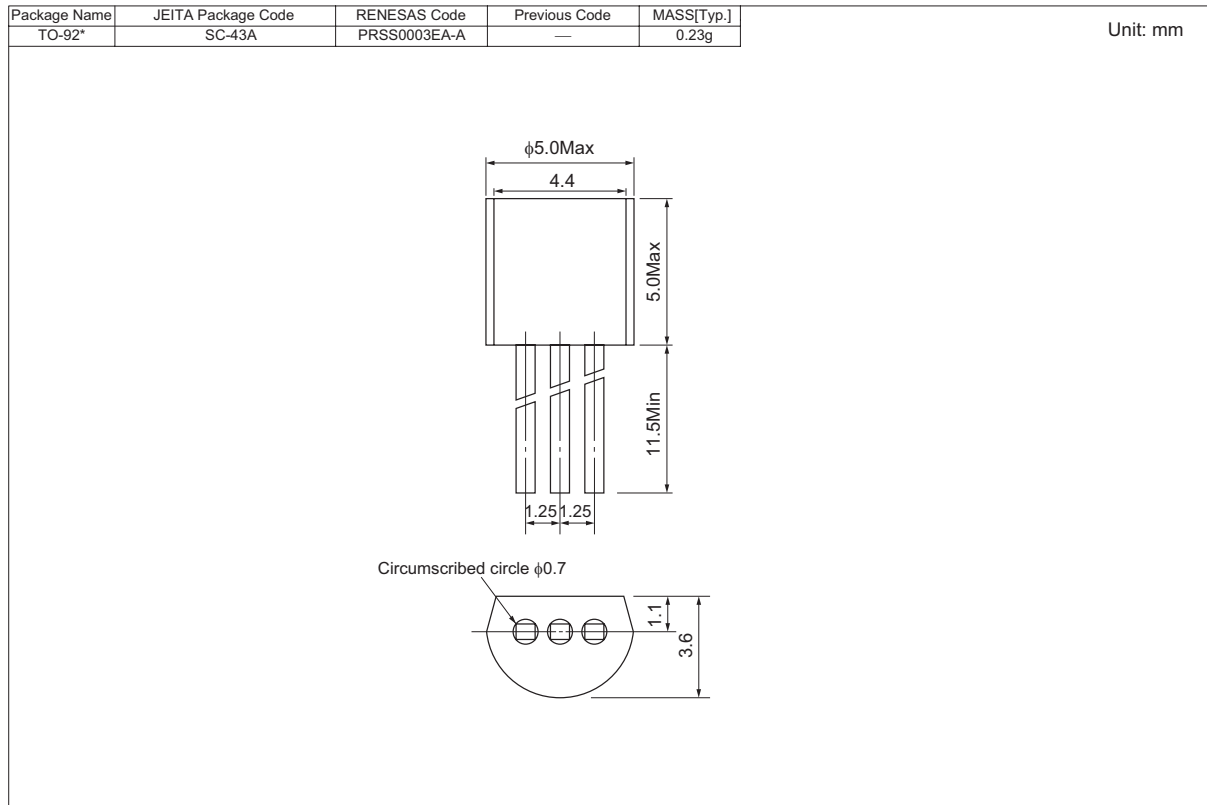


Gate Trigger Characteristics Test Circuits



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Package Dimensions



Order Code

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Straight type	Vinyl sack	500	Type name	BCR08AM-12A
Lead form	Vinyl sack	500	Type name – Lead forming code	BCR08AM-12A-A6
Form A8	Taping	2000	Type name – TB	BCR08AM-12A-TB

Note : Please confirm the specification about the shipping in detail.

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